

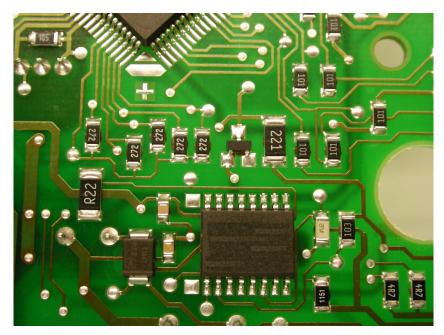
# **SN100C® LEAD-FREE WAVE SOLDER**

(Tin/Copper/Nickel/Germanium)

Bridge-free wave soldering at 250 - 255°c with economical Sn-Cu-Ni+ Ge solder is possible with SN100C® from Nihon superior and DKL Metals

WITH MORE THAN 8000 LINES IN COMMERCIAL PRODUCTION, SOME FOR OVER 13 YEARS AND MANY HUNDREDS OF MILLIONS OF BOARDS IN SERVICE, SN100C IS PROVEN IN LEAD-FREE WAVE SOLDER PRODUCTION

- No shorts on QFP to 0.5mm, 100 Pins
- Good through-hole penetration
- Eutectic alloy
- Does not contain bismuth or silver
- Lower drossing than other lead free alloys
- Less aggressive to stainless steel compared to SAC (Sn/Cu/Ag) alloys
- Smooth, bright well-formed fillets
- Does not require nitrogen atmosphere
- Bridge-free, icicle-free soldering
- Low cost of ownership
- Easy pot management low Cu leaching rate



Wave-soldered with SN100C®

#### Description

**SN100C**® is a lead-free solder alloy developed and patented by Nihon Superior Co. Ltd of Japan. The alloy is based on the tin/copper eutectic alloy with the addition of a small quantity of nickel and germanium which modifies its behaviour to the extent that in wave-soldering the resultant alloy exhibits fluidity and wetting properties comparable to that of the traditional tin/lead solder it is designed to replace. Wave-soldering performance easily matches that of the more expensive silver containing solders available. Low aggressivity to stainless steel, low copper leaching rates and low dross rates combine to offer substantial cost savings to the user, **making SN100C**® **the most cost-effective alloy choice for lead free wave-soldering.** 





## **Technical Specification**

TEST		SOLDER ALLOY			
		SN100C®	Sn63 Pb37	TEST METHOD	
Alloy System		Sn/Cu/Ni + Ge	Sn/Pb		
Melting Temperature °C		227°C Eutectic	183°C Eutectic	DSC	
Specific Gravity		7.4	8.4	S.G. Measuring Apparatus	
Specific Heat (J/kg • K)		220	176	Estimated	
Thermal Conductivity (J/m • s • K)		64	50	Estimated	
Tensile Strength (M • Pa)		32	44	10mm/min (25°C)	
Elongation (%)		48	25	10mm/min (25°C)	
	230°C	-	91		
	240°C	77	92	]	
Spread Factor (%)	250°C	77	93	JIS Z 3197 (NS-828A FLUX)	
	260°C	78	93		
	280°C	78	-		
Electrical Resistance (μΩ	m)	0.13	0.17	Four Terminal Method	
Copper Erosion Rate at 260°C		Approx. 2 minutes	Approx. 1	Time for complete erosion of	
Copper Liosion Rate at 2	.00 C	Approx. 2 minutes	minute	1.8mm dia. wire	
		>300HRS	20HRS	145°C, 1kg load	
Creep Strength (Time to Failure)		>300HRS	3HRS	150°C, 1kg load	
		>300HRS	7 MIN	180°C, 1kg load	
Thermal Shock		>1000 cycles	500-600 cycles	-40/+80°C Each 1HR	
Electromigration		>1000HRS	>1000HRS	40°C, 95% RH &	
				85°C, 85%RH	
Whisker Test		>1000HRS	>1000HRS	50°C	

## **Recommended Operating Parameters**

One of the major process changes using SN100C® and other lead free alloys compared with standard tin/lead Sn63 is the difference between the processing temperature and the melting point of the alloys: Therefore care must be taken to ensure the process settings are optimised. Based on over 13 years of production on 8000+ wave solder machines, the following guidelines have been established:

- Control air drafts in machine.
- Close off openings.
- Adjust damper to reduce drafts.

- Minimise gap between preheaters and pot
- Ensure cooling fans blow away from pot.

• Ensure adequate preheat for board type as listed below:

PC Board Type	Recommended Preheat Temperature Range (°C)
Single-sided. Simple double-sided	90-100
Double-sided	100-115
Heavy double-sided, multilayer	120-135

• Ensure temperature in the wave meets requirement listed below:

PC Board Type	Recommended Pot Temperature Range (°C)		
Single-sided. Simple double-sided	250-255°C		
Double-sided	255-260°C		
Heavy double-sided, multilayer	260-265°C		





#### **Alloy Specification:**

Element	Typical SN100C®	Typical SN100C®e	Recommended T.A.L Wave
Tin (Sn)	Bal	Bal	
Copper (Cu)	0.65	<0.20	0.85
Nickel (Ni)	0.050	0.050	0.04 - 0.08
Zinc (Zn)	<0.0005	<0.0005	0.005
Silver (Ag)	0.001	0.001	0.05
Antimony (Sb)	0.010	0.010	0.05
Lead (Pb)	0.02	0.02	0.1
Cadmium (Cd)	0.0001	0.0001	0.005
Bismuth (Bi)	0.002	0.002	0.05
Iron (Fe)	0.003	0.003	0.02
Arsenic (As)	0.001	0.001	0.05
Aluminium (Al)	<0.0001	<0.0001	0.002
Gold (Au)	0.0002	0.0002	0.080

## **Recommended Solder Bath Operating Conditions**

To ensure the continued optimum performance of SN100C® solder in your manufacturing process it is important that periodic analysis of the solder bath contents is undertaken to verify that the alloy composition is maintained within strict limits. Any build-up of undesirable impurity elements or an increase in the copper content may lead to poor flow characteristics, potentially compromising joint structure, with a consequent rise in defect rates. In most applications rising copper levels can be controlled by topping-up bath levels with SN100C®e copper-free alloy.

Verification of bath copper content is easy with our free solder bath analysis programme which gives you a full analysis along with trend graphs allowing you to track copper and other contaminant levels over time.

### **Availability**

STYLE	NOM. WEIGHT	DIMENSIONS	PACKING
Bar	1kg	300 x 32 x 12mm	20kg Carton
Autofeed Ingot	4kg	500 x 45 x 33mm	Ingot
Chunks (chopped bar)	-	-	20kg Tub

Please contact us with any specific non standard bar or ingot size to check on availability.

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**DKL Metals Limited** 

Bo'ness Road, Grangemouth, Stirlingshire, FK3 9XF, U.K.

Telephone: +44(0) 1506 847710 Fax: +44 (0)1506 848199 E-mail: sales@dklmetals.co.uk Web: www.dklmetals.co.uk